

P-Channel MOSFET

60V 300mA SOT-23 AEC-Q101

MFT6PA30S23A

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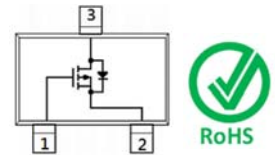
FEATURE

- $R_{DS(ON)} < 4\Omega$, $V_{GS} = -10V$, $I_D = -500mA$
- $R_{DS(ON)} < 6\Omega$, $V_{GS} = -4.5V$, $I_D = -200mA$
- $R_{DS(ON)} < 13\Omega$, $V_{GS} = -2.5V$, $I_D = -50A$
- Advanced Trench Process Technology
- Application: Relay Driver, Speed Line Driver
- AEC-Q101 Qualified



MECHANICAL DATA

- Case: SOT-23 Package
- Terminals: Solderable per MIL-STD-750, Method 2026

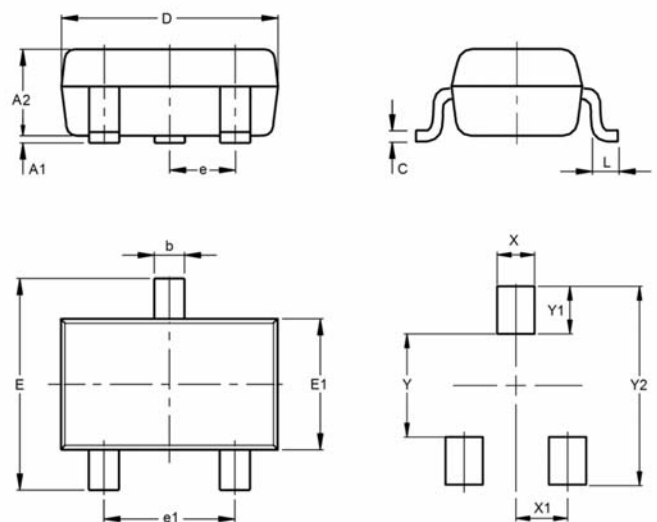


MAXIMUM RATINGS

Parameter		Symbol	Value	Unit
Drain-Source Voltage		V_{DS}	-60	V
Gate-Source Voltage		V_{GS}	± 20	V
Drain Current – Continuous		I_D	-300	mA
Drain Current – Pulsed		I_{DM}	-1000	mA
Power Dissipation	$T_A = 25^\circ C$	P_D	500	mW
	Derate above $T_A = 25^\circ C$		4	mW/ $^\circ C$
Operating Junction and Storage Temperature		T_J, T_{stg}	-55 to 150	$^\circ C$
Thermal Resistance, Junction to Ambient		$R_{\theta JA}$	250	$^\circ C / W$

DIMENSIONS

Item	Min (mm)	Max (mm)
A1	0.00	0.10
A2	0.90	1.10
b	0.35	0.50
C	0.08	0.20
D	2.80	3.04
e	0.90	1.00
e1	1.80	2.00
E	2.20	2.60
E1	1.20	1.40
L	0.15	
X	0.80	
X1	0.95	
Y	1.10	
Y1	0.90	
Y2	2.90	



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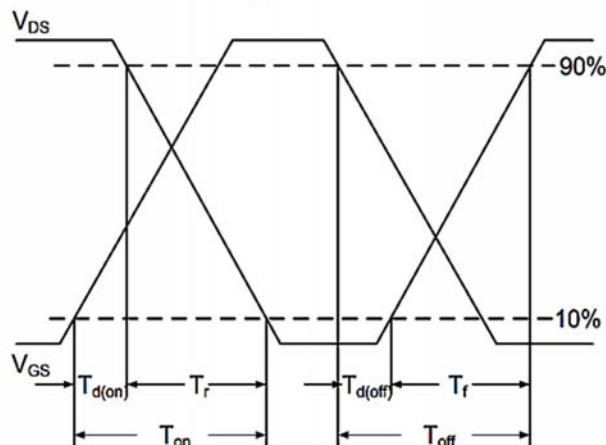
ELECTRICAL CHARACTERISTICS

Off Characteristics	Conditions	Symbol	Min	Typ.	Max	Unit
Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=250\mu A$	BV_{DSS}	-60	--	--	V
Gate Threshold Voltage	$V_{GS}=V_{DS}, I_D=-250\mu A$	$V_{GS(th)}$	-1.0	-1.5	-2.5	V
Gate Leakage Current	$V_{DS}=0V, V_{GS}=\pm 20V$	I_{GSS}	--	--	± 100	nA
Zero Gate Voltage Drain Current	$V_{DS}=-48V, V_{GS}=0V$	I_{DSS}	--	--	-1	μA
On Characteristics	Conditions	Symbol	Min	Typ.	Max	Unit
Static Drain-Source On-Resistance	$V_{GS}=-10V, I_D=-500mA$	$R_{DS(on)}$	--	2.4	4	Ω
	$V_{GS}=-4.5V, I_D=-200mA$		--	2.65	6	
	$V_{GS}=-2.5V, I_D=-50mA$		--	4.5	13	
Dynamic Characteristics	Conditions	Symbol	--	Typ.	Max	Unit
Input Capacitance	$V_{DS}=-25V, V_{GS}=0V$ $F=1.0MHz$	C_{iss}	--	51	--	pF
Output Capacitance		C_{oss}	--	15	--	
Reverse Transfer Capacitance		C_{rss}	--	2.2	--	
Turn-On Delay Time	$V_{DD}=-25V, I_D=-100mA,$ $V_{GS}=-10V,$ $R_G=6\Omega$	$T_{d(on)}$	--	4.8	--	nS
Rise Time		T_r	--	19	--	
Turn-Off Delay Time		$T_{d(off)}$	--	52	--	
Fall Time		T_f	--	32	--	
Total Gate Charge	$V_{DS}=-25V, V_{GS}=-4.5V,$ $I_D=-100mA$	Q_g	--	1.1	--	nC
Gate-Source Charge		Q_{gs}	--	0.3	--	
Gate-Drain Charge		Q_{gd}	--	0.2	--	
Drain-Source Body Diode	Conditions	Symbol	Min	Typ.	Max	Unit
Diode Forward Voltage	$I_S=-500mA, V_{GS}=0V$	V_{SD}	--	-0.95	-1.3	V
Drain-Source Diode Forward Current	--	I_S	--	--	-300	mA

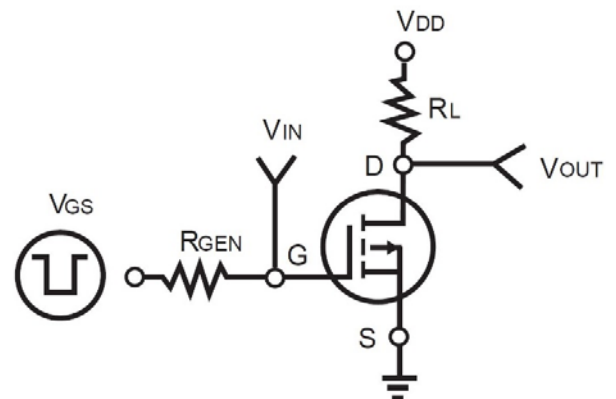
Note:

1. Pulse width<300us, Duty cycle<2%.
2. Essentially independent of operating temperature typical characteristics.
3. $R_{\theta JA}$ is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins mounted on a 1 inch FR-4 with 2oz. square pad of copper.
4. The maximum current rating is package limited.
5. Guaranteed by design not subject to production testing.

Switching Time Waveform



Switching Test Circuit



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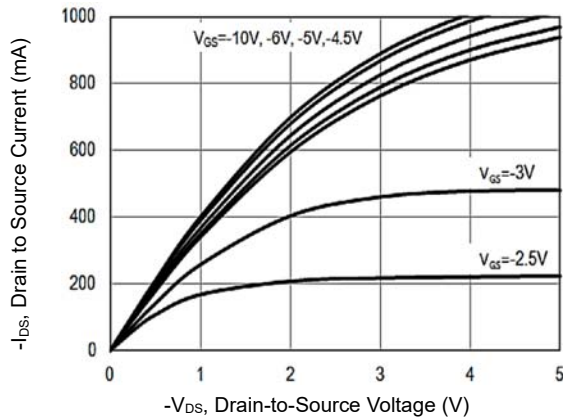
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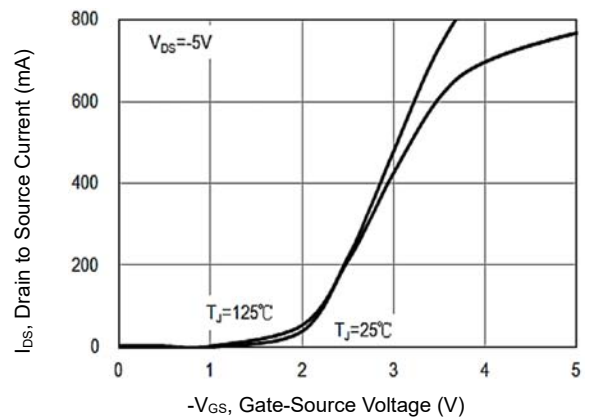
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CHARACTERISTIC CURVES

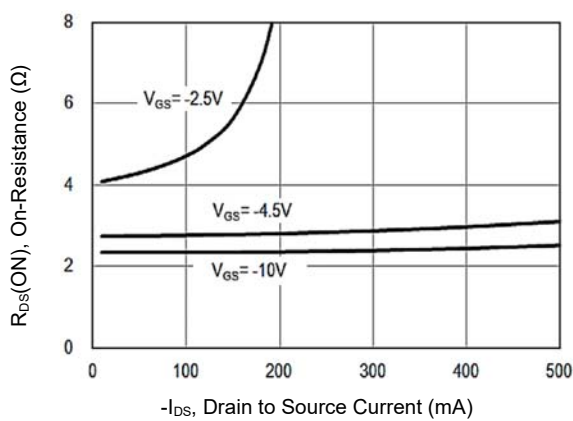
On Region Characteristics



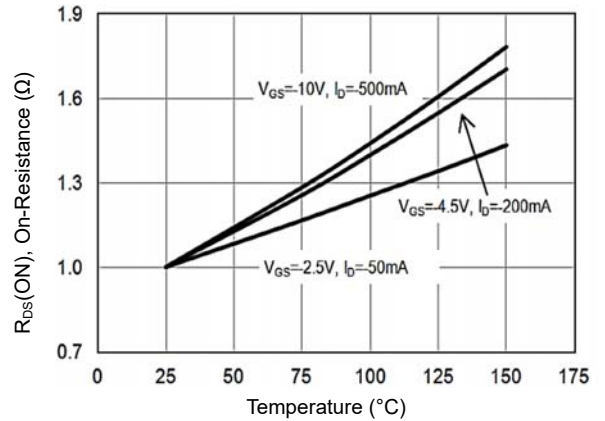
Transfer Characteristics



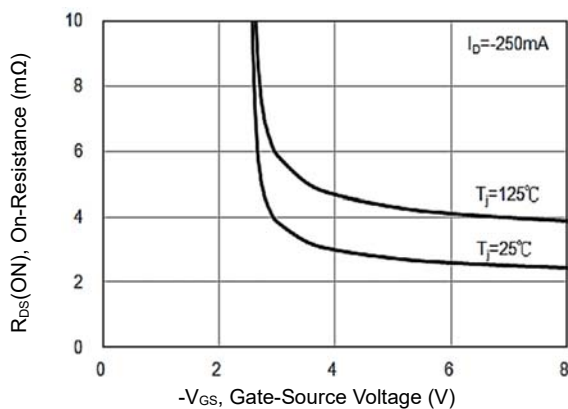
On-Resistance vs. Drain Current



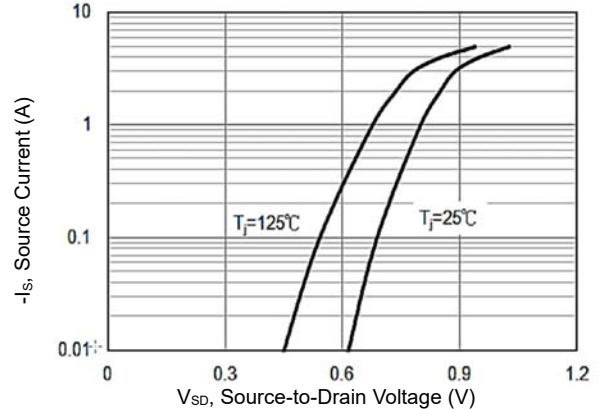
Capacitance



On-Resistance Variation with V_GS



Body Diode Characteristics



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